



BAV99HDW

SURFACE MOUNT SWITCHING DIODE ARRAY

Features

- Fast Switching Speed
- High Reverse Breakdown Voltage
- Low Leakage Current
- Low Capacitance
- Two "BAV99" Circuits in One Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An automotive-compliant part is available under separate datasheet (<u>BAV99HDWQ</u>)

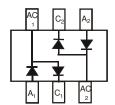
Mechanical Data

- Package: SOT363
- Package Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe;
 (Lead-Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.006 grams (Approximate)

SOT363







Top View Internal Schematic

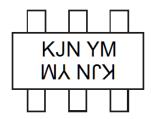
Ordering Information (Notes 4)

Part Number	Pankaga	Packing		
Part Number	Package	Qty.	Carrier	
BAV99HDW-13	SOT363	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



KJN = Product Type Marking Code

YM = Date Code Marking

Y = Year (ex: K = 2023); A Bar on Top of the "Y" Denotes AT Site

M = Month (ex: 9 = September)

Date Code Key

Year	2015		2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	С		K	L	М	N	Р	R	S	Т	U	٧
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM V _R	100	٧	
RMS Reverse Voltage	V _R (RMS)	71	V	
Forward Continuous Current (Note 5)	IFM	200	mA	
Repetitive Peak Forward Current	IFRM	500	mA	
@ t = 1.0μs			4	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0ms	IFSM	1.0	Α
@ t = 1.0s			0.5	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance Junction to Ambient Air (Note 5)	Reja	500	°C/W
Thermal Resistance Junction to Solder Point (Note 6)	Rejsp	260	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

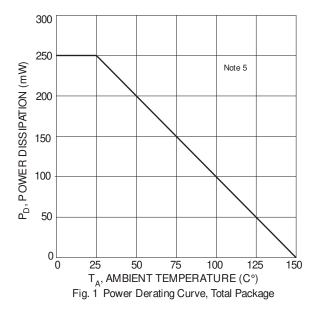
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

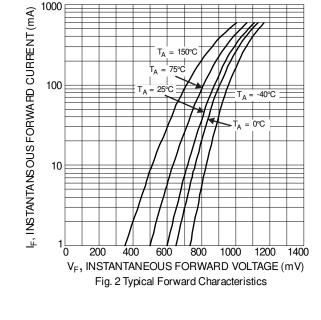
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	100	_	V	$I_R = 2.5\mu A$
		_	0.715	٧	IF = 1.0mA
Forward Voltage	VF	_	0.855		I _F = 10mA
Forward Voltage	VF	_	1.0		IF = 50mA
		_	1.25		I _F = 150mA
		_	0.5	μΑ	V _R = 80V
Povorno Current (Noto 7)		_	50		$V_R = 80V, T_J = +150$ °C
Reverse Current (Note 7)	IR	_	30		V _R = 25V, T _J = +150°C
		_	30	nA	V _R = 25V
Total Capacitance	Ст	_	1.5	рF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	too		4.0	ns	IF = IR = 10mA
Hevelse Hecovery Hille	trr		7.0	115	$I_{RR} = 0.1 \times I_{R}, R_{L} = 100\Omega$
Forward Recovery Voltage	V _{FR}	_	1.75	V	$I_F = 10 \text{ mA}$; $t_R = 20 \text{ns}$

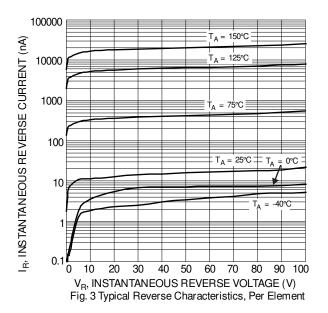
Notes:

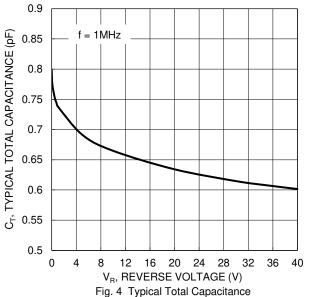
- 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 6. Soldering points at pins AC₁, AC₂ and C₁, C₂.
 7. Short duration pulse test used to minimize self-heating effect.









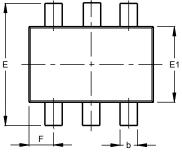


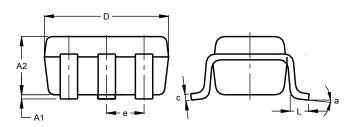


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





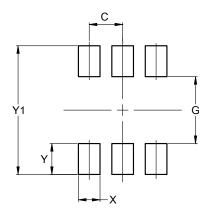


SOT363						
Dim	Min	Max	Тур			
A 1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Υ	0.600
V1	2 500



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